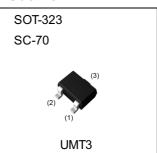


Medium power transistor (60V, 0.5A)

Parameter	Value
V <sub>CEO</sub>	60V
Ι <sub>C</sub>	500mA





Inner circuit

### Features

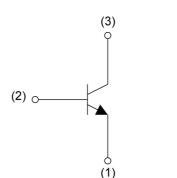
1)High speed switching.

(Tf:Typ.:80ns at I<sub>C</sub>=500mA)

2)Low saturation voltage, typically

(Typ.:150mV at  $I_C$ =100mA,  $I_B$ =10mA)

- 3)Strong discharge power for inductive load and capacitance load.
- 4)Complements the 2SA2088U3.



(1) Emitter(2) Base(3) Collector

## Application

LOW FREQUENCY AMPLIFIER, HIGH SPEED SWITCHING

### Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SC5876U3	SOT-323 (UMT3)	2021	T106	180	8	3000	VS

## • Absolute maximum ratings ( $T_a = 25^{\circ}C$ )

Parameter	Symbol	Values	Unit
Collector-base voltage	V <sub>CBO</sub>	60	V
Collector-emitter voltage	V <sub>CEO</sub>	60	V
Emitter-base voltage	V <sub>EBO</sub>	6	V
	Ι <sub>C</sub>	500	mA
Collector current	I <sub>CP</sub> *1	1.0	Α
Power dissipation	P <sub>D</sub> *2	200	mW
Junction temperature	Tj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

## •Electrical characteristics ( $T_a = 25^{\circ}C$ )

Deremeter	Current al	Conditions	Values			L locit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	$BV_{CBO}$	Ι <sub>C</sub> = 100μΑ	60	-	-	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = 1mA	60	-	-	V
Emitter-base breakdown voltage	$BV_{EBO}$	Ι <sub>Ε</sub> = 100μΑ	6	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 40V	-	-	1	μA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 4V	-	-	1	μA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 100mA, I <sub>B</sub> = 10mA	-	150	300	mV
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> = 2V, I <sub>C</sub> = 50mA	120	-	390	-
Transition frequency	f <sub>T</sub> *3	V <sub>CE</sub> = 10V, I <sub>E</sub> = -100mA, f = 100MHz	-	300	-	MHz
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = 10V, I <sub>E</sub> = 0mA, f = 1MHz	-	5	-	pF
Turn-On time	t <sub>on</sub>	I <sub>C</sub> = 500mA, I <sub>B1</sub> = 50mA,	-	70	-	ns
Storage time	t <sub>stg</sub>	$I_{B2} = -50 \text{mA},$ $V_{CC} \simeq 25 \text{V},$	-	130	-	ns
Fall time	t <sub>f</sub>	R <sub>L</sub> = 50Ω See test circuit	-	80	-	ns

#### hFE values are calssified as follows :

rank	Q	R	-	-	-
hFE	120-270	180-390	-	-	-

\*1 Pw=10ms

\*2 Each terminal mounted on a reference land.

\*3 Pulsed



## • Electrical characteristic curves ( $T_a = 25^{\circ}C$ )

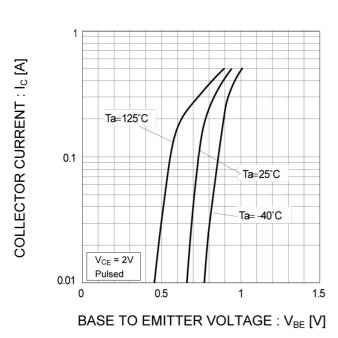
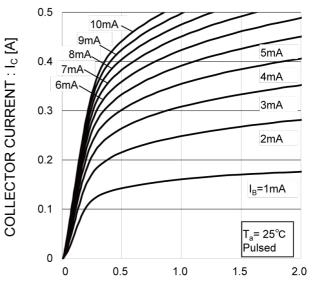


Fig.1 Ground Emitter Propagation Characteristics

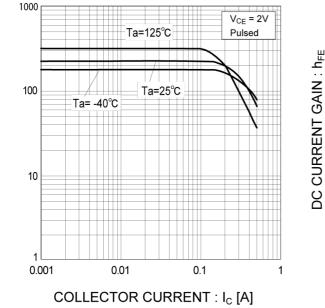
## Fig.2 Typical Output Characteristics



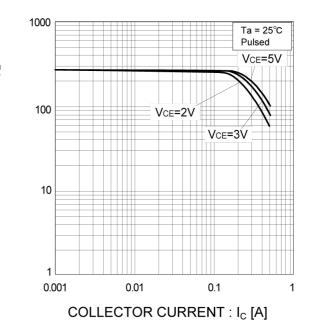
COLLECTOR TO EMITTER VOLTAGE : V<sub>CE</sub> [V]

## Fig.3 DC Current Gain vs. Collector Current (I)

DC CURRENT GAIN : he

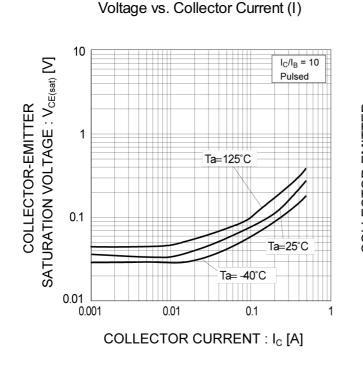


### Fig.4 DC Current Gain vs. Collector Current (II)

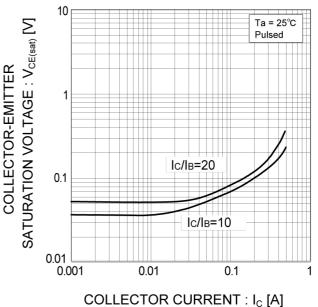


## ●Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.5 Collector-Emitter Saturation



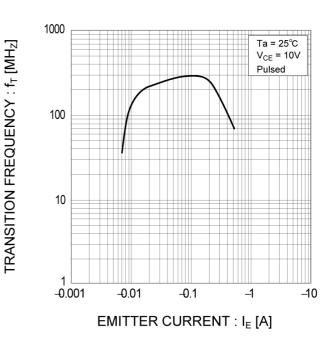
## Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current (II)



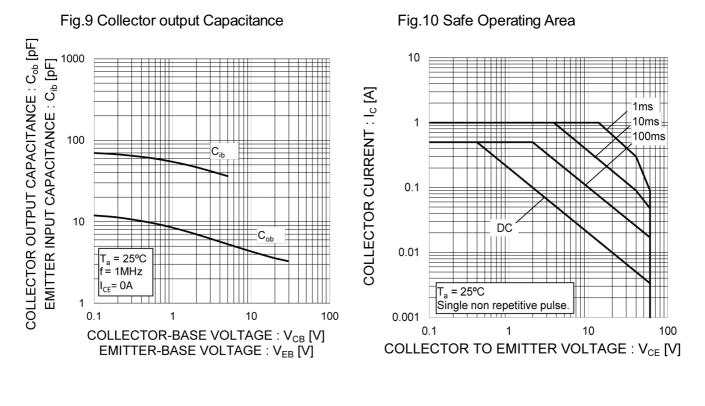
# Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

10  $I_{\rm C}/I_{\rm B} = 10$ SATURATION VOLTAGE : VBE(sat) [V] Pulsed Ta= −40°C **BASE-EMITTER** 1 Ta=25°C Ta=125℃ 0.1 0.01 0.001 0.01 0.1 1 COLLECTOR CURRENT : Ic [A]

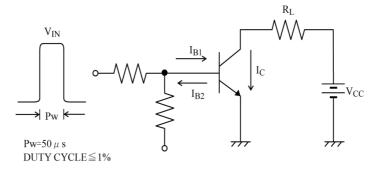
Fig.8 Transition Frequency

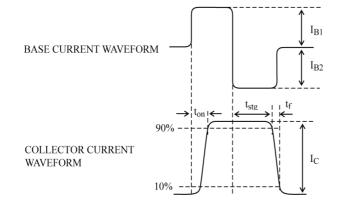


## • Electrical characteristic curves( $T_a = 25^{\circ}C$ )



#### SWITCHING TIME TEST CIRCUIT

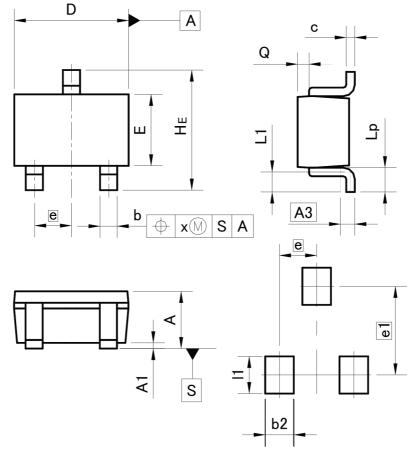






#### Dimensions

UMT3



Pattern of terminal position areas
[Not a recommended pattern of soldering pads]

DIM	MILIMETERS		INCHES			
DIM	MIN	MAX	MIN	MAX		
A	0.80	1.00	0.031	0.039		
A1	0.00	0.10	0.000	0.004		
A3	0.3	25	0.010			
b	0.15	0.30	0.006	0.012		
с	0.10	0.20	0.004	0.008		
D	1.90	2.10	0.075	0.083		
E	1.15	1.35	0.045	0.053		
е	0.0	65	0.026			
HE	2.00	2.20	0.079	0.087		
L1	0.20	0.50	0.008	0.020		
Lp	0.25	0.55	0.010	0.022		
Q	0.10	0.30	0.004	0.012		
x	-	0.10	_	0.004		
DIM	MILIMETERS		INCHES			
	MIN	MAX	MIN	MAX		
b2	-	0.50	-	0.020		

Dimension in mm/inches

\_

e1 |1



0.061

\_

0.026

0.65

1.55

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(Note1) Medical Equipment Classification of the Specific Applications
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JÁPAN	USA	EU	CHINA	
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII	
CLASSⅣ	CLASSIII	CLASSⅢ	CLASSI	

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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
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  - [h] Use of the Products in places subject to dew condensation
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For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
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